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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Not For New Designs
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	SIO, UART/USART
Peripherals	LED, POR, Voltage Detect, WDT
Number of I/O	22
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21112fp-u0

Email: info@E-XFL.COM

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R8C/11 Group SINGLE-CHIP 16-BIT CMOS MICROCOMPUTER

REJ03B0034-0160 Rev.1.60 Jan 27, 2006

1. Overview

This MCU is built using the high-performance silicon gate CMOS process using a R8C/Tiny Series CPU core and is packaged in a 32-pin plastic molded LQFP. This MCU operates using sophisticated instructions featuring a high level of instruction efficiency. With 1M bytes of address space, it is capable of executing instructions at high speed.

1.1 Applications

Electric household appliance, office equipment, housing equipment (sensor, security), general industrial equipment, audio, etc.

1.3 Block Diagram

Figure 1.1 shows this MCU block diagram.

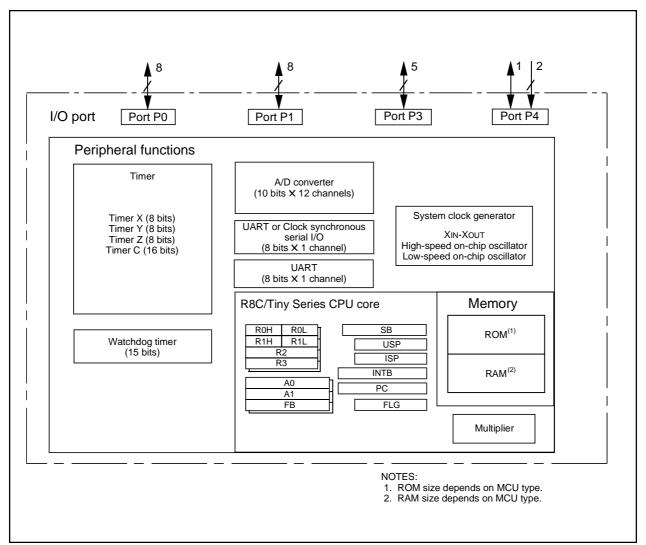


Figure 1.1 Block Diagram

1.4 Product Information

Table 1.2 lists the product information.

Table 1.2 Product Information

As of January 2006

Type No.	ROM capacity	RAM capacity	Package type	Remarks
R5F21112FP	8K bytes	512 bytes	PLQP0032GB-A	Flash memory version
R5F21113FP	12K bytes	768 bytes	PLQP0032GB-A	
R5F21114FP	16K bytes	1K bytes	PLQP0032GB-A	
R5F21112DFP	8K bytes	512 bytes	PLQP0032GB-A	D version
R5F21113DFP	12K bytes	768 bytes	PLQP0032GB-A	
R5F21114DFP	16K bytes	1K bytes	PLQP0032GB-A	

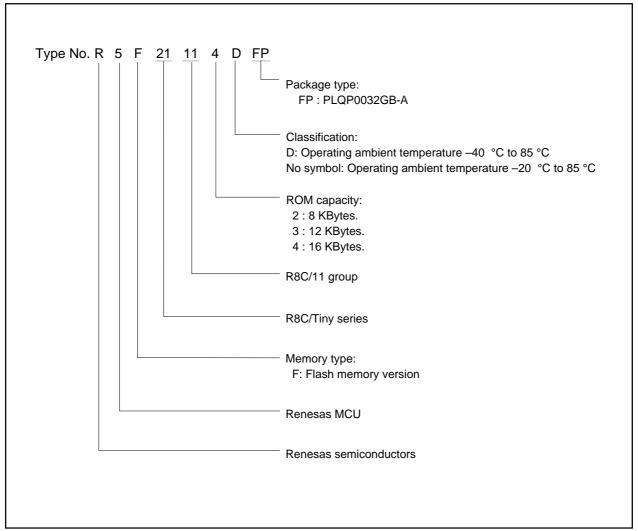


Figure 1.2 Type No., Memory Size, and Package

1.5 Pin Assignments

Figure 1.3 shows the pin configuration (top view).

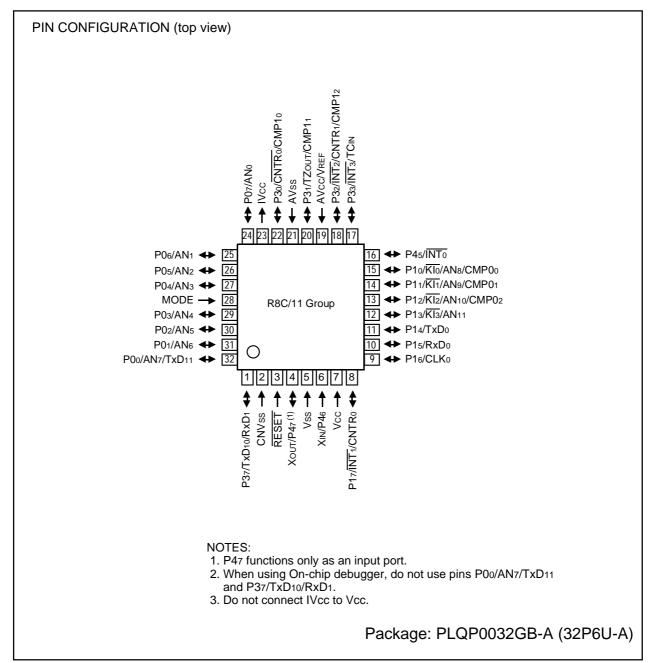


Figure 1.3 Pin Assignments (Top View)

1.6 Pin Description

Table 1.3 shows the pin description

Table 1.3 Pin description

Signal name	Pin name	I/O type	Function
Power supply	Vcc,	Į	Apply 2.7 V to 5.5 V to the Vcc pin. Apply 0 V to the
input	Vss		Vss pin.
IVcc	IVcc	0	This pin is to stabilize internal power supply.
			Connect this pin to Vss via a capacitor (0.1 μ F).
			Do not connect to Vcc.
Analog power	AVcc, AVss	I	Power supply input pins for A/D converter. Connect the
supply input			AVcc pin to Vcc. Connect the AVss pin to Vss. Connect a
			capacitor between pins AVcc and AVss.
Reset input	RESET	I	Input "L" on this pin resets the MCU.
CNVss	CNVss	I	Connect this pin to Vss via a resistor.
MODE	MODE	I	Connect this pin to Vcc via a resistor.
Main clock input	XIN	1	These pins are provided for the main clock generating circuit I/O. Connect a ceramic resonator or a crys-
Main clock output	YOUT	0	tal oscillator between the XIN and XOUT pins. To use
I Wall Clock output	7001		an externally derived clock, input it to the XIN pin and
			leave the XOUT pin open.
INT interrupt input	INTo to INT3	I	INT interrupt input pins.
Key input interrupt		1	Key input interrupt pins.
Timer X	CNTR ₀	I/O	Timer X I/O pin
	CNTR ₀	0	Timer X output pin
Timer Y	CNTR ₁	I/O	Timer Y I/O pin
Timer Z	TZOUT	0	Timer Z output pin
Timer C	TCIN	I	Timer C input pin
	CMP00 to CMP02,	0	Timer C output pins
	CMP10 to CMP12		
Serial interface	CLK ₀	I/O	Transfer clock I/O pin.
	RxD0, RxD1	I	Serial data input pins.
	TxD0, TxD10,	0	Serial data output pins.
	TxD11		·
Reference voltage	VREF	I	Reference voltage input pin for A/D converter. Con-
input			nect the VREF pin to Vcc.
A/D converter	ANo to AN11	I	Analog input pins for A/D converter
I/O port	P00 to P07,	I/O	These are 8-bit CMOS I/O ports. Each port has an I/O
	P10 to P17,		select direction register, allowing each pin in that port
	P30 to P33, P37,		to be directed for input or output individually.
	P45		Any port set to input can select whether to use a pull-
			up resistor or not by program.
			P10 to P17 also function as LED drive ports.
Input port	P46, P47	1	Port for input-only

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU registers. The CPU has 13 registers. Of these, R0, R1, R2, R3, A0, A1 and FB comprise a register bank. Two sets of register banks are provided.

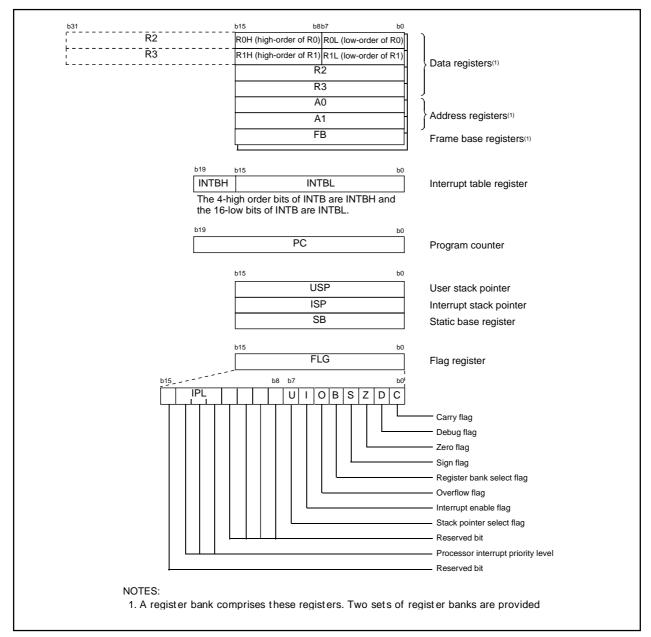


Figure 2.1 CPU Register

2.1 Data Registers (R0, R1, R2 and R3)

R0 is a 16-bit register for transfer, arithmetic and logic operations. The same applies to R1 to R3. The R0 can be split into high-order bit (R0H) and low-order bit (R0L) to be used separately as 8-bit data registers. The same applies to R1H and R1L as R0H and R0L. R2 can be combined with R0 to be used as a 32-bit data register (R2R0). The same applies to R3R1 as R2R0.

2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. They also are used for transfer, arithmetic and logic operations. The same applies to A1 as A0. A0 can be combined with A0 to be used as a 32-bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB is a 20-bit register indicates the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC, 20 bits wide, indicates the address of an instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointer (SP), USP and ISP, are 16 bits wide each.

The U flag of FLG is used to switch between USP and ISP.

2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

2.8 Flag Register (FLG)

FLG is a 11-bit register indicating the CPU state.

2.8.1 Carry Flag (C)

The C flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic logic unit.

2.8.2 Debug Flag (D)

The D flag is for debug only. Set to "0".

2.8.3 Zero Flag (Z)

The Z flag is set to "1" when an arithmetic operation resulted in 0; otherwise, "0".

2.8.4 Sign Flag (S)

The S flag is set to "1" when an arithmetic operation resulted in a negative value; otherwise, "0".

2.8.5 Register Bank Select Flag (B)

The register bank 0 is selected when the B flag is "0". The register bank 1 is selected when this flag is set to "1".

2.8.6 Overflow Flag (O)

The O flag is set to "1" when the operation resulted in an overflow; otherwise, "0".

2.8.7 Interrupt Enable Flag (I)

The I flag enables a maskable interrupt.

An interrupt is disabled when the I flag is set to "0", and are enabled when the I flag is set to "1". The I flag is set to "0" when an interrupt request is acknowledged.

2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to "0", USP is selected when the U flag is set to "1".

The U flag is set to "0" when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

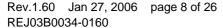
2.8.9 Processor Interrupt Priority Level (IPL)

IPL, 3 bits wide, assigns processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has greater priority than IPL, the interrupt is enabled.

2.8.10 Reserved Bit

When write to this bit, set to "0". When read, its content is indeterminate.





4. Special Function Register (SFR)

SFR(Special Function Register) is the control register of peripheral functions. Tables 4.1 to 4.4 list the SFR information

Table 4.1 SFR Information(1)⁽¹⁾

Address	Register	Symbol	After reset
000016	,		
000116			
000216			
000316			
000416	Processor mode register 0	PM0	0016
000516	Processor mode register 1	PM1	0016
000616	System clock control register 0	CM0	011010002
000716 000816	System clock control register 1 High-speed on-chip oscillator control register 0	CM1 HR0	001000002 0016
000916	Address match interrupt enable register	AIER	XXXXXXX002
000A16	Protect register	PRCR	00XXX0002
000B16	High-speed on-chip oscillator control register 1	HR1	4016
000C16	Oscillation stop detection register	OCD	000001002
000D16	Watchdog timer reset register	WDTR	XX16
000E16	Watchdog timer start register	WDTS	XX16
000F16	Watchdog timer control register	WDC	000111112
001016	Address match interrupt register 0	RMAD0	0016
001116 001216			0016
001216			X016
001416	Address match interrupt register 1	RMAD1	0016
001516		1000	0016
001616			X016
001716			
001816	(2)		
001916	Voltage detection register 1 ⁽²⁾	VCR1	000010002
001A ₁₆	Voltage detection register 2 ⁽²⁾	VCR2	0016 ⁽³⁾
001B ₁₆			100000002 ⁽⁴⁾
001D16			
001D16			
001E ₁₆	INTO input filter select register	INT0F	XXXXX0002
001F16	Voltage detection interrupt register ⁽²⁾	D4INT	0016 ⁽³⁾
			010000012 ⁽⁴⁾
002016			
002116			
002216			
002316			
002516			
002616			
002716			
002816			
002916			
002A16			
002B ₁₆			
002C16			
002E16			
002F16			
003016			
003116			
003216			
003316			
003416			
003516 003616			
003616			
003716			
003916			
003A16			
003B ₁₆			
003C16			
003D16			
003E16			
003F16			

X : Undefined NOTES:

^{1.} Blank spaces are reserved. No access is allowed.

^{2.} Software reset or the watchdog timer reset does not affect this register.
3. Owing to Reset input.
4. In the case of RESET pin = H retaining.

Table 4.3 SFR Information(3)⁽¹⁾

Address	Register	Symbol	After reset
008016	Timer Y, Z mode register	TYZMR	0016
008116	Prescaler Y register	PREY	FF16
008216	Timer Y secondary register	TYSC	FF16
008316	Timer Y primary register	TYPR	FF16
008416	Timer Y, Z waveform output control register	PUM	0016
008516	Prescaler Z register	PREZ	FF16
008616	Timer Z secondary register	TZSC	FF16
008716	Timer Z primary register	TZPR	FF16
008816	1 , 0		
008916			
008A16	Timer Y, Z output control register	TYZOC	0016
008B16	Timer X mode register	TXMR	0016
008D16	Prescaler X register	PREX	FF16
008C16	Timer X register	TX	FF16
\vdash	Timer count source set register	TCSS	0016
008E16	Timer count source set register	1000	0010
008F16	There are O are with the control of	TO	0040
009016	Timer C register	TC	0016
009116			0016
009216			
009316		1	
009416			
009516			
009616	External input enable register	INTEN	0016
009716			
009816	Key input enable register	KIEN	0016
009916			
009A16	Timer C control register 0	TCC0	0016
009B ₁₆	Timer C control register 1	TCC1	0016
009C16	Capture, compare 0 register	TM0	0016
009D16			0016 ⁽²⁾
009E16	Compare 1 register	TM1	FF16
009E16	Osmparo i registor	11011	FF16
00A016	UART0 transmit/receive mode register	U0MR	0016
00A116	UARTO bit rate register	U0BRG	XX16
00A216	UART0 transmit buffer register	U0TB	XX16
00A316	OAK TO transmit burier register	UUIB	XX16 XX16
00A416	UART0 transmit/receive control register 0	U0C0	000010002
00A516	UART0 transmit/receive control register 1	U0C1	000010002
00A516	UARTO receive buffer register	UORB	XX16
00A016 00A716	OAR TO Teceive buller register	UUKB	XX16
	LIADT1 transmit/ressit/s made register	U1MR	0016
00A816	UART1 transmit/receive mode register		
00A916	UART1 bit rate register	U1BRG	XX16
00AA16	UART1 transmit buffer register	U1TB	XX16
00AB16		11100	XX16
00AC16	<u> </u>	U1C0	000010002
00AD16	UART1 transmit/receive control register 1	U1C1	000000102
00AE16	UART1 receive buffer register	U1RB	XX16
00AF16			XX16
00B016	UART transmit/receive control register 2	UCON	0016
00B116			
00B216			
00B316			
00B416			
00B516			T
00B616			
00B616 00B716			
00B716 00B816			
00B716 00B816 00B916			
00B716 00B816 00B916 00BA16			
00B716 00B816 00B916 00BA16 00BB16			
00B716 00B816 00B916 00BA16 00BB16 00BC16			
00B716 00B816 00B916 00BA16 00BB16 00BC16			
00B716 00B816 00B916 00BA16 00BB16 00BC16			

<sup>X : Undefined
NOTES:
1. Blank spaces are reserved. No access is allowed.
2. When output compare mode (the TCC13 bit in the TCC1 register = 1) is selected, the value after reset is set to "FFFF16".</sup>

5. Electrical Characteristics

Table 5.1 Absolute Maximum Ratings

Symbol	Parameter	Condition	Rated value	Unit
Vcc	Supply voltage	Vcc=AVcc	-0.3 to 6.5	V
AVcc	Analog supply voltage	Vcc=AVcc	-0.3 to 6.5	V
Vı	Input voltage		-0.3 to Vcc+0.3	٧
Vo	Output voltage		-0.3 to Vcc+0.3	V
Pd	Power dissipation	Topr=25 °C	300	mW
Topr	Operating ambient temperature		-20 to 85 / -40 to 85 (D version)	°C
Tstg	Storage temperature		-65 to 150	°C

Table 5.2 Recommended Operating Conditions

0	Demonstra		Conditions	Standard			
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
Vcc	Supply voltage			2.7		5.5	V
AVcc	Analog supply v	oltage o			VCC(3)		V
Vss	Supply voltage				0		V
AVss	Analog supply v	oltage .			0	-	V
VIH	"H" input voltag	е		0.8Vcc		Vcc	V
VIL	"L" input voltage	е		0		0.2Vcc	V
I _{OH (sum)}	"H" peak all output currents	Sum of all pins' IOH (peak)				-60.0	mA
I _{OH (peak)}	"H" peak output	current				-10.0	mA
I _{OH} (avg)	"H" average out	out current				-5.0	mA
I _{OL (sum)}	"L" peak all output currents	Sum of all pins' IOL (peak)			_	60	mA
I _{OL (peak)}	"L" peak output	Except P10 to P17				10	mA
* /	current	P10 to P17	Drive capacity HIGH	-		30	mA
			Drive capacity LOW			10	mA
I _{OL (avg)}	"L" average	Except P10 to P17				5	mA
· OL (avg)	output current	P10 to P17	Drive capacity HIGH			15	mA
			Drive capacity LOW			5	mA
f (XIN)	Main clock inpu	t oscillation frequency	3.0V ≤ Vcc ≤ 5.5V	0		20	MHz
			2.7V ≤ Vcc < 3.0V	0		10	MHz

^{1.} Vcc = AVcc = 2.7 to 5.5V at Topr = -20 to 85 °C / -40 to 85 °C, unless otherwise specified.
2. The typical values when average output current is 100ms.
3. Hold Vcc=AVcc.

Table 5.4 Flash Memory Version Electrical Characteristics

Symbol	Parameter	Measuring condition	Standard			
Cymbol	Falametei	Weasuring condition	Min.	Тур.	Max	Unit
_	Program/erase endurance		100	_	_	times
-	Byte program time			50	400	μs
_	Block erase time			0.4	9	S
td(SR-ES)	Time delay from suspend request until erase suspend		_		8	ms
-	Erase Suspend Request Interval		10		_	ms
_	Program, Erase voltage		2.7		5.5	V
_	Read voltage		2.7		5.5	V
_	Program, Erase temperature		0		60	°C
_	Data hold time ⁽²⁾	Ambient temperature=55 °C	20			year

NOTES:

- 1. Referenced to Vcc1=AVcc=2.7 to 5.5V at Topr = 0 to 60 °C unless otherwise specified.
- 2. The data hold time includes time that the power supply is off or the clock is not supplied.

Table 5.5 Voltage Detection Circuit Electrical Characteristics

Symbol	Parameter	Measuring condition		1.1		
Cymbol	1 diamotor	Wiededining containen	Min.	Тур.	Max.	Unit
Vdet	Voltage detection level		3.3	3.8	4.3	V
_	Voltage detection interrupt request generating time ⁽²⁾		_	40	_	μs
_	Voltage detection circuit self consumption current	VC27=1, VCC=5.0V	_	600	_	nA
td(E-A)	Waiting time till voltage detection circuit operation starts ⁽³⁾		_	_	20	μs
Vccmin	Minimum value of microcomputer operation voltage		2.7	_	_	V

NOTES:

- 1. The measuring condition is Vcc=AVcc=2.7V to 5.5V and Topr= -40°C to 85 °C.
- 2. This shows the time until the voltage detection interrupt request is generated since the voltage passes Vdet.
- 3. This shows the required time until the voltage detection circuit operates when setting to "1" again after setting the VC27 bit in the VCR2 register to "0".

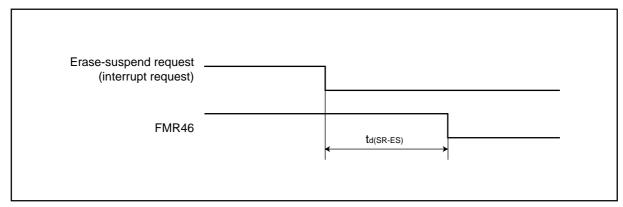


Figure 5.2 Time delay from Suspend Request until Erase Suspend

Table 5.6 Reset Circuit Electrical Characteristics (When Using Hardware Reset 2^(1, 3))

Symbol	Parameter	Measuring condition		Unit		
- Cyrribor	r arameter	g condition	Min.	Тур.	Max.	Unit
Vpor2	Power-on reset valid voltage	-20°C ≤ Topr < 85°C	_	_	Vdet	V
tw(Vpor2- Vdet)	Supply voltage rising time when power-on reset is canceled ⁽²⁾	$-20^{\circ}\text{C} \le \text{Topr} < 85^{\circ}\text{C}, \text{ tw(por2)} \ge 0\text{s}^{(4)}$	_	_	100	ms

NOTES:

- 1. The voltage detection circuit which is embedded in a microcomputer is a factor to generate the hardware reset 2. Refer to 5.1.2 Hardware Reset 2 of Hardware Manual for details.
- 2. This condition is not applicable when using with Vcc ≥ 1.0V.
- 3. When turning power on after the external power has been held below the valid voltage (Vpor1) for greater than 10 seconds, refer to Table 5.7 Reset Circuit Electrical Characteristics (When Not Using Hardware Reset 2).
- 4. tw(por2) is time to hold the external power below effective voltage (Vpor2).

Table 5.7 Reset Circuit Electrical Characteristics (When Not Using Hardware Reset 2)

Symbol	Parameter	Measuring condition		I I a is		
Cynnbon	ramotor	Wodeding condition	Min.	Тур.	Max.	Unit
Vpor1	Power-on reset valid voltage	-20°C ≤ Topr < 85°C	_	_	0.1	V
tW(Vpor1- Vdet)	Supply voltage rising time when power-on reset is canceled	$0^{\circ}\text{C} \leq \text{Topr} \leq 85^{\circ}\text{C}, \text{ tw(por1)} \geq 10\text{s}^{(2)}$	_	_	100	ms
tW(Vpor1- Vdet)	Supply voltage rising time when power-on reset is canceled	-20°C ≤ Topr < 0°C, tw(por1) ≥ 30 s ⁽²⁾	_	_	100	ms
tW(Vpor1- Vdet)	Supply voltage rising time when power-on reset is canceled	-20°C ≤ Topr < 0°C, tw(por1) ≥ 10s ⁽²⁾	_	_	1	ms
tW(Vpor1- Vdet)	Supply voltage rising time when power-on reset is canceled	$0^{\circ}\text{C} \leq \text{Topr} \leq 85^{\circ}\text{C}, \text{ tw(por1)} \geq 1\text{s}^{(2)}$	_	_	0.5	ms

NOTES

- 1. When not using hardware reset 2, use with Vcc ≥ 2.7V.
- 2. tw(por1) is time to hold the external power below effective voltage (Vpor1).

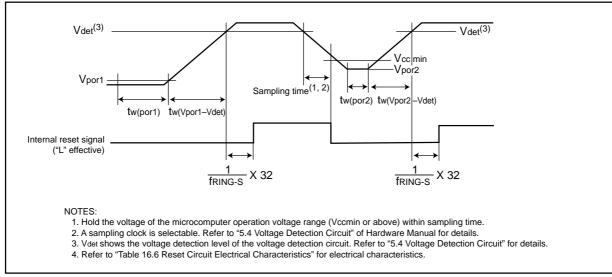


Figure 5.3 Reset Circuit Electrical Characteristics

Timing requirements (Unless otherwise noted: Vcc = 5V, Vss = 0V at Topr = 25 °C) [Vcc=5V]

Table 5.12 XIN input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(XIN)	XIN input cycle time	50	_	ns
twh(XIN)	XIN input HIGH pulse width	25	_	ns
twL(XIN)	XIN input LOW pulse width	25	_	ns

Table 5.13 CNTR0 input, CNTR1 input, INT2 input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tC(CNTR0)	CNTR0 input cycle time	100	_	ns
tWH(CNTR0)	CNTR0 input HIGH pulse width	40	_	ns
tWL(CNTR0)	CNTR0 input LOW pulse width	40	_	ns

Table 5.14 TCIN input, INT3 input

Symbol	Parameter	Stan	Unit	
		Min.	Max.	
tC(TCIN)	TCIN input cycle time	400 ⁽¹⁾	_	ns
tWH(TCIN)	TCIN input HIGH pulse width	200 ⁽²⁾	_	ns
tWL(TCIN)	TCIN input LOW pulse width	200 ⁽²⁾	_	ns

NOTES:

- 1. When using the Timer C input capture mode, adjust the cycle time above (1/Timer C count source frequency x 3).
- 2. When using the Timer C input capture mode, adjust the pulse width above (1/Timer C count source frequency x 1.5).

Table 5.15 Serial Interface

Symbol	mbol Parameter		Standard	
		Min.	Max.	
tc(ck)	CLKi input cycle time	200	_	ns
tw(ckH)	CLKi input HIGH pulse width	100	_	ns
tW(CKL)	CLKi input LOW pulse width	100	_	ns
td(C-Q)	TxDi output delay time	_	80	ns
th(C-Q)	TxDi hold time	0	_	ns
tsu(D-C)	RxDi input setup time	35	_	ns
th(C-D)	RxDi input hold time	90	_	ns

Table 5.16 External interrupt INTO input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tw(INH)	INTO input HIGH pulse width	250 ⁽¹⁾	-	ns
tw(INL)	INTO input LOW pulse width	250 ⁽²⁾	1	ns

NOTES:

- 1. When selecting the digital filter by the $\overline{\text{INT0}}$ input filter select bit, use the $\overline{\text{INT0}}$ input HIGH pulse width to the greater value, either (1/ digital filter clock frequency x 3) or the minimum value of standard.
- 2. When selecting the digital filter by the $\overline{\text{INT0}}$ input filter select bit, use the $\overline{\text{INT0}}$ input LOW pusle width to the greater value, either (1/ digital filter clock frequency x 3) or the minimum value of standard.

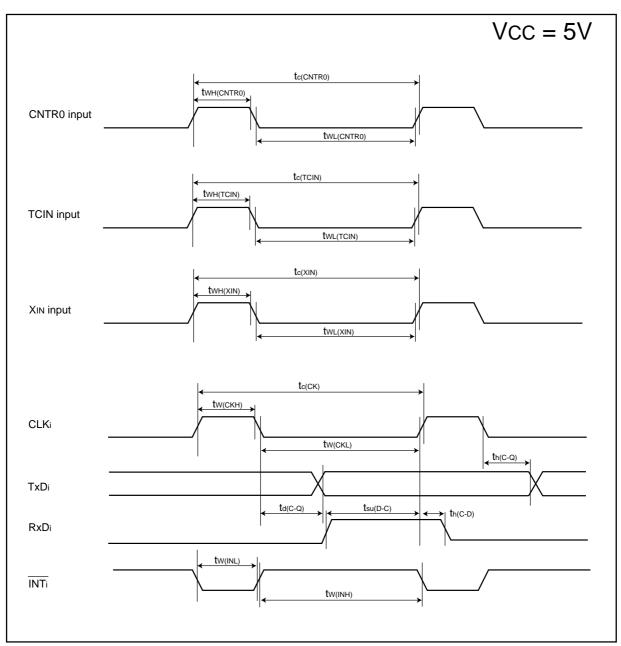


Figure 5.4 Vcc=5V timing diagram

Timing requirements (Unless otherwise noted: Vcc = 3V, Vss = 0V at Topr = 25 °C) [Vcc=3V]

Table 5.19 XIN input

Symbol	Parameter Standard		Unit	
		Min.	Max.	
tc(XIN)	XIN input cycle time	100	_	ns
twh(XIN)	XIN input HIGH pulse width	40	_	ns
twl(XIN)	XIN input LOW pulse width	40	_	ns

Table 5.20 CNTR0 input, CNTR1 input, INT2 input

Symbol	Parameter Stan		dard	Unit
		Min.	Max.	
tC(CNTR0)	CNTR0 input cycle time	300	_	ns
tWH(CNTR0)	CNTR0 input HIGH pulse width	120	_	ns
tWL(CNTR0)	CNTR0 input LOW pulse width	120	_	ns

Table 5.21 TCIN input, INT3 input

Symbol	Parameter		Standard	
		Min.	Max.	
tc(TCIN)	TCIN input cycle time	1200 ⁽¹⁾	-	ns
tWH(TCIN)	TCIN input HIGH pulse width	600 ⁽²⁾	-	ns
tWL(TCIN)	TCIN input LOW pulse width	600 ⁽²⁾	_	ns

NOTES:

- 1. When using the Timer C input capture mode, adjust the cycle time above (1/ Timer C count source frequency x 3).
- 2. When using the Timer C input capture mode, adjust the pulse width above (1/ Timer C count source frequency x 1.5).

Table 5.22 Serial Interface

Symbol	ymbol Parameter		Standard	
		Min.	Max.	
tc(ck)	CLKi input cycle time	300	_	ns
tw(ckH)	CLKi input HIGH pulse width	150	_	ns
tw(ckl)	CLKi input LOW pulse width	150	_	ns
td(C-Q)	TxDi output delay time	_	160	ns
th(C-Q)	TxDi hold time	0	_	ns
tsu(D-C)	RxDi input setup time	55	_	ns
th(C-D)	RxDi input hold time	90	_	ns

Table 5.23 External interrupt INTO input

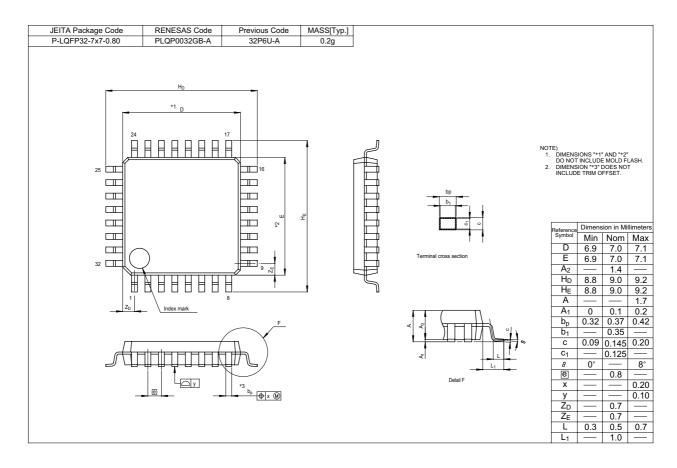
Symbol	Parameter Standar		Standard	
		Min.	Max.	
tW(INH)	INTO input HIGH pulse width	380 ⁽¹⁾	_	ns
tw(INL)	INTO input LOW pulse width	380 ⁽²⁾	1	ns

NOTES:

- 1. When selecting the digital filter by the $\overline{\text{INT0}}$ input filter select bit, use the $\overline{\text{INT0}}$ input HIGH pulse width to the greater value, either (1/ digital filter clock frequency x 3) or the minimum value of standard.
- 2. When selecting the digital filter by the $\overline{\text{INT0}}$ input filter select bit, use the $\overline{\text{INT0}}$ input LOW pusle width to the greater value, either (1/ digital filter clock frequency x 3) or the minimum value of standard.

R8C/11 Group Package Dimensions

Package Dimensions



REVISION HISTORY

R8C/11 Group Datasheet

Rev.	Date		Description
		Page	Summary
1.00	Jun. 19, 2003		First edition issued
1.10	Sep. 08, 2003	2 5 6 10 12 14	Table 1.1: Shortest instruction execution time and f(XIN) changed Figure 1.3: Pin name changed from TXOUT to CNTR0 Table 1.3: Pin name changed from TXOUT to CNTR0 The value of HR1 register after reset changed The value of TC register after reset changed Chapter "5. Electrical Characteristics" added
1.20	Oct. 31, 2003	2 6 11 14 15 17 19 20 21 22 23	Table 1.1: Power consumption values added Table 1.3: Resistor value for CNVss and MODE deleted Register name of address 005016 modified from CMP2IC to CMP1IC, register name of address 005C16 modified from CMP1IC to CMP0IC Table 5.2: Note 3 and Note 4 deleted tsamp in Table 5.3 deleted Figure 5.1 added Table 5.10: Vcc changed from "4.2 to 5.5V" to "3.3V to 5.5V", low-power on-chip oscillator changed from "on 100kHz" to "125kHz", XIN=5MHz deleted and XIN=10MHz added in high-speed mode and medium-speed mode, VC27="0" added in stop mode measuring condition, data added and modified Table 11 to Table 15 added Figure 5.2 added Table 5.16: Note 1, f(BCLK)=5 MHz changed to 10 MHz Table 5.17: low-power ring oscillator changed from "on 100kHz" to "125kHz", XIN=5MHz deleted and XIN=10MHz added in high-speed mode and medium-speed mode, VC27="0" added in stop mode measuring condition, data added and modified Table 5.18 to Table 5.22 added Figure 5.3 added
1.30	Dec 05, 2003	4 15	Table 1.2 : ** deleted Table 5.4 revised
1.40	Sep 30, 2004	all pages 2 5 6 9 10-13 12 14 15 16 17 18	Words standardized (on-chip oscillator, serial interface, A/D) Table 1.1 revised Figure 1.3, NOTES 3 added Table 1.3 revised Figure 3.1, NOTES added One body sentence in chapter 4 added; Title of Table 4.1 to 4.4 added Table 4.3 revised; Table 4.4 revised Table 5.2 revised Table 5.3 revised Table 5.4 revised; Table 16.5 revised Table 5.6, 5.7 adn 5.8 revised; Figure 5.3 revised Table 5.9 revised; Table 5.10 revised

REVISION HISTORY

R8C/11 Group Datasheet

Rev.	Date		Description
		Page	Summary
1.60	Jan.27.2006	19 22 23	Table 5.11 Electrical Characteristics (2) [Vcc=5V] NOTES: 1, 2 revised Measuring condition Stop mode: "Topr = 25 °C" Table 5.17 Electrical Characteristics (3) [Vcc=3V] "P1₀ to P1₂ Except Xout" → "Except P1₀ to P1₂, Xout" revised Table 5.18 Electrical Characteristics (4) [Vcc=3V] NOTES: 1, 2 revised Measuring condition Stop mode: "Topr = 25 °C"

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